



Material Composition Declaration

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This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.

Adobe Reader version 7.0.5 is required to complete this declaration.

1752-2 1.1	IPC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175x	Form Type * Distribute	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informat
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Supplier Information

Company Name * ST MICROELECTRONICS	Company Unique ID	Unique ID Authority	Response Date * N/A	Response Document ID				
Contact Name *	Title - Contact	Phone - Contact *	Email - Contact *		Duplicate Contact -> Authorized Representative			
Authorized Representative * GIUSEPPE VITALI PALMA	Title - Representative APM MD CHAMPION	Phone - Representative * N/A	Email - Representative * N/A		Supplier Comments or URL for Additional Information			
Requester Item Number	Mfr Item Number	Mfr Item Name	Effective Date	Version	Manufacturing Site	Weight *	UOM	Unit Type
	LM211DT	FDO7*0211AC6	2011-06-13	A	BO2A	7,701	mg	Each
Alternate Recommendation	PACKAGE: SO 08 .15 JEDEC		Alternate Item Comments		ECOPACK1/ROHS; BSA: CD00146670			

Manufacturing Process Information

Terminal Plating / Grid Array Material Nickel/Palladium/Gold (Ni/Pd/Au)	Terminal Base Alloy CU Alloy	J-STD-020 MSL Rating 1	Peak Process Body Temperature 260 C	Max Time at Peak Temperature 30 seconds	Number of Reflow Cycles 3
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Comments

DISCLAIMER: While STMicroelectronics has endeavored to provide information which is accurate and up to date, this document and its contents are provided on a strict "as is"

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Lock Supplier Fields

RoHS Material Composition Declaration

Declaration Type *

Simplified

RoHS Directive
2002/95/EC

RoHS Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium

Supplier certifies that it gathered the information it provides in this form concerning RoHS restrictive substances using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form.

RoHS Declaration *

1 - Item(s) does not contain RoHS restricted substances per the definition above

Supplier Acceptance *

Accepted

Exemptions: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.

Declaration Signature

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	Item/SubItem Name		Homogeneous Material	Weight	Unit of Measure		Level	Substance Category		Substance	CAS	Exempt	Weight	Unit of Measure	Tolerance		PPM				
															-	+					
+I	-I	FDO7*0211AC6	+M -M	Silicon Die	1.295	mg	+C -C	Supplier	Silicon die	+S -S	Silicon	7440-21-3		1.294	mg			999,22			
										+C -C	Supplier	die metallization	+S -S	Aluminium(Al)	7429-90-5		0.001	mg			772
			+M -M	Leadframe	29.802	mg	+C -C	Supplier	alloy	+S -S	Copper (Cu)	7440-50-8		29.763	mg			998,69			
										+S -S	Iron (Fe)	7439-89-6		0.014	mg			470			
										+S -S	Iron Phosphide (FeP)	26508-33-8		0.025	mg			839			
			+M -M	Leadframe coating	0.144	mg	+C -C	Supplier	coating	+S -S	Nickel (Ni)	7440-02-0		0.134	mg	0		930,55			
										+S -S	Palladium (Pd)	7440-05-3		0.005	mg			34,722			
										+S -S	Gold (Au)	7440-57-5		0.005	mg			34,722			
			+M -M	Die Attach	0.288	mg	+C -C	Supplier	glue	+S -S	Silver (Ag)	7440-22-4		0.216	mg			750,00			
										+S -S	Epoxy Cresol Novolak	29690-82-2		0.071	mg			246,52			
										+S -S	1-isopropyl-2,2-dimethyl	6846-50-0		0.001	mg			3,472			
			+M -M	Bonding wire	0.092	mg	+C -C	Supplier	Bonding wire	+S -S	Gold (Au)	7440-57-5		0.092	mg			1,000,0			
			+M -M	Encapsulation	45.479	mg	+C -C	Supplier	Moulding Compound	+S -S	Epoxy Cresol Novolak	29690-82-2		4.548	mg			100,00			
										+S -S	phenol resin	9003-35-4		2.274	mg			50,001			
										+S -S	Carbon Black	1333-86-4		0.455	mg			10,005			
										+S -S	Silica, vitreous	60676-86-0		36.382	mg			799,97			
							+C -C	Supplier	Antimony/Antimony C	+S -S	Antimony Trioxide	1309-64-4		0.91	mg			20,009			
							+C -C	JIG I	Brominated Flame Ret	+S -S	Brominated epoxy resin	68928-70-1		0.91	mg			20,009			